

# AN-1751 4A LM20k Reference Designs

#### **ABSTRACT**

This application note discusses the design options using the high performance 4A synchronous buck converters, LM20124, LM20134, and LM20144.

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Introduction www.ti.com

#### 1 Introduction

The LM20124, LM20134, and LM20144 are a full-featured family of high performance 4A synchronous buck converters. These devices are tailored to operate over an input voltage range of 2.95V to 5.5V and each can be optimized to meet many different performance requirements. The LM20124 operates at a fixed frequency and only requires 11 components to generate a solution. The LM20144 is similar to the LM20124 except the frequency of the device can be varied from 460 kHz to 1.5 MHz with an external resistor. This gives the power supply designer the flexibility to trade-off inductor size and efficiency. The LM20134 features a synchronization input pin that synchronizes the internal oscillator to an external signal to keep the switching regulators operating with the same phase which is critical in many noise sensitive designs.

The reference designs discussed will show how the 4A devices can be optimized for size, efficiency and transient response. The trade-offs made for each design will be discussed for the various 4A devices. Test results for including efficiency, output voltage ripple, and transient response will be shown for each design.

## 2 Solution Optimized for Efficiency

The LM20144 was selected for a high-efficiency design because the operating frequency can be adjusted to minimize switching losses. A low switching frequency will minimize the switching losses; however, this will also require a solution with a higher value inductance with a higher DC series resistance (DCR). Since the LM20k family of devices feature very low switching losses a switching frequency of 620 kHz was selected. This choice of operating frequency balances the inductance DCR losses with the switching frequency losses to give a small, highly efficient solution. This design can also work with the LM20133 synchronizing to 620 kHz.

## 2.1 Inductor Selection

As per the data sheet recommendations, the inductor value should initially be chosen to give a peak-to-peak ripple current equal to roughly 30% of the maximum output current. The peak-to-peak inductor ripple current can be calculated by the equation:

$$\Delta I_{P-P} = \frac{(V_{IN} - V_{OUT}) \times D}{L \times f_{SW}}$$
(1)

Rearranging the above equation and solving for the inductance reveals that for this application ( $V_{IN} = 5V$ ,  $V_{OUT} = 3.3V$ ,  $D = V_{IN}/V_{OUT} = .66$ ,  $f_{SW} = 620$  kHz, and  $I_{OUT} = 4A$ ) the nominal inductance value is roughly 1.51  $\mu$ H. Once an inductance value is calculated, an actual inductor needs to be selected based on a tradeoff between physical size, efficiency, and current carrying capability. The purpose of this design is to maximize the efficiency therefore, the choice of small value inductors with lower series resistance (DCR) can be examined provided the output current plus one-half the peak to peak ripple current does not exceed the device current limit. Examining several inductor vendors a TDK SPM6530T-1R5M100 inductor was selected. This 1.5  $\mu$ H inductor results in a peak-to-peak ripple current of 1.2A when the converter is operating from 5V and 3.3V. For a design targeting high efficiency the TDK SPM6530T-1R5M100 inductor offers a good balance between efficiency (9.7 m $\Omega$  DCR), size, and saturation current rating (10A  $I_{SAT}$  rating).

### 2.2 Output Capacitor Selection

The value of the output capacitor in a buck regulator influences the voltage ripple that will be present on the output voltage, as well as the large signal output voltage response to a load transient. Given the peak-to-peak inductor current ripple (which can be calculated using equation 1) the output voltage ripple can be approximated by the equation:

$$\Delta V_{OUT} = \Delta I_{P-P} \times \left[ R_{ESR} + \frac{1}{8 \times f_{SW} \times C_{OUT}} \right]$$
 (2)

The variable  $R_{\rm ESR}$  above refers to the ESR of the output capacitor. As can be seen in the above equation, the ripple voltage on the output can be divided into two parts, one of which is attributed to the AC ripple current flowing through the ESR of the output capacitor and another due to the AC ripple current actually charging and discharging the output capacitor. The output capacitor also has an effect on the amount of droop that is seen on the output voltage in response to a load transient event.



For this design a TDK 100  $\mu$ F ceramic capacitor is selected for the output capacitor to provide good transient and DC performance in a relatively small package. From the technical specifications of this capacitor, the ESR at the 1.5 MHz switching frequency is roughly 2 m $\Omega$ , and the effective in-circuit capacitance is approximately 45  $\mu$ F (reduced from 100  $\mu$ F due to the 3.3V DC bias). With these values, the peak-to-peak voltage ripple on the output when operating from a 5V input can be calculated to be 8 mV.

## 2.3 Compensation Selection

The compensation network was selected using the excel design tool (available online) to give a crossover frequency of 50 kHz. For this target crossover frequency, operating conditions, and filter components the excel calculator suggested a value of  $C_{\text{C1}}$  of 2.2 nF and a value of  $R_{\text{C1}}$  of 9.09 k $\Omega$ .

The final schematic for a 5V or 3.3V to 1.2V conversion is shown in Figure 1.

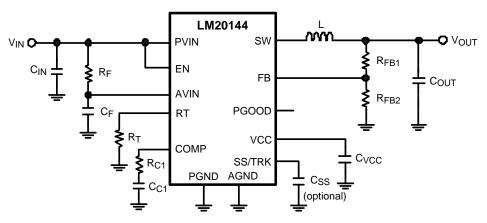


Figure 1. 3.3V Output Solution Optimized for Efficiency

Table 1. High Efficiency Bill of Materials ( $V_{IN} = 5V$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT(MAX)} = 4A$ ,  $f_{SW} = 620$  kHz)

Designator	Description	Part Number	Manufacturer	Qty
U1	Synchronous Buck Regulator	LM20144	Texas Instruments	1
C <sub>IN</sub>	47µF, 1206, X5R, 6.3V	C3216JB0J476M	TDK	1
C <sub>OUT</sub>	100μF, 1210, X5R, 6.3V	C3225X5R0J107M	TDK	1
L	1.5μH, 9.7 mΩ	SPM6530T-1R5M100	TDK	1
R <sub>F</sub>	1Ω, 0603	CRCW06031R0J-e3	Vishay-Dale	1
$C_{F}$	1μF, 0603, X7R, 10V	GRM188R71A105KA01	Murata	1
C <sub>VCC</sub>	1μF, 0603, X7R, 10V	GRM188R71A105KA01	Murata	1
R <sub>C1</sub>	9.09kΩ,0603	CRCW06039091F	Vishay-Dale	1
C <sub>C1</sub>	2.2nF,0603,X7R,25V	VJ0603Y222KXA	Vishay-Vitramon	1
C <sub>SS</sub>	33nF,0603,X7R,25V	VJ0603Y333KXXA	Vishay-Vitramon	1
R <sub>FB1</sub>	30.9kΩ,0603	CRCW06033092F	Vishay-Dale	1
$R_{FB2}$	10kΩ, 0603	CRCW06031002F-e3	Vishay-Dale	1
R <sub>T</sub>	196kΩ, 0603	CRCW06031963F-e3	Vishay-Dale	1



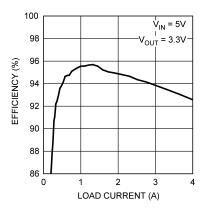


Figure 2. Efficiency vs I<sub>OUT</sub>

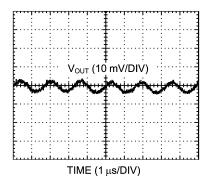


Figure 3. Output Voltage Ripple

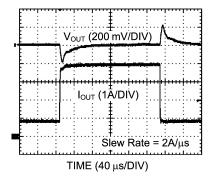


Figure 4. Transient Response

### 3 Optimizing a Solution for Size

For the smallest possible solution size the fixed frequency LM20124 device was selected since the 1MHz free running oscillator minimizes both the component count and inductor size. To minimize the solution size careful attention needs to be paid to the selection of the external components such as the inductor, input, and output capacitors.

# 3.1 Inductor Selection

The inductor should be sized for approximately 30% ripple current. For  $V_{IN} = 5V$ ,  $V_{OUT} = 1.2V$ ,  $f_{SW} = 1MHz$ , and  $I_{OUT} = 4A$ , the ideal inductance value can be calculated from equation 1 to be 0.76  $\mu$ H. Once an inductance value is calculated, an actual inductor needs to be selected based on a trade-off between physical size, efficiency, and current carrying capability. Since the purpose of this design is minimize the size, it is possible to select inductor values smaller than 0.76 $\mu$ H, as long as the output current plus one-



half the peak to peak ripple current does not exceed the device current limit. After examining several inductor vendors, a Vishay IHLP1616BZER1R0M11 inductor was selected. This  $1\mu$ H inductor results in a peak-to-peak ripple current of 1.66A and 909 mA when the converter is operating from 5V and 3.3V respectively. For a design where size is critical, the Vishay IHLP1616BZER1R0M11 inductor offers a small size in addition to low DC losses (24 m $\Omega$  DCR), and saturation current rating (5A  $I_{SAT}$  rating).

#### 3.2 Output Capacitor Selection

A TDK 47  $\mu$ F ceramic capacitor is selected for the output capacitor to provide good transient and DC performance in a relatively small package. From the technical specifications of this capacitor, the ESR at the 1.5 MHz switching frequency is roughly 3 m $\Omega$ , and the effective in-circuit capacitance is approximately 28  $\mu$ F (reduced from 47  $\mu$ F due to the 1.2V DC bias). With these values, the peak-to-peak voltage ripple on the output when operating from a 5V input can be calculated to be 10 mV.

# 3.3 Compensation Selection

The compensation network was selected using the excel design tool (available online) to give a crossover frequency of 65 kHz. For this target crossover frequency, operating conditions, and filter components the excel design tool suggested a value of  $C_{C1}$  of 1.8 nF and a value of  $R_{C1}$  of 3.92 k $\Omega$ .

The final schematic for a 5V or 3.3V to 1.2V conversion is shown in Figure 1.

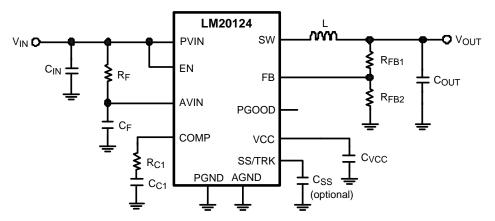


Figure 5. 1.2V Output Solution Optimized for Size

Table 2. Bill of Materials (Small solution size,  $V_{IN} = 5V$ ,  $V_{OUT} = 1.2V$ ,  $I_{OUT(MAX)} = 4A$ )

Designator	Description	Part Number	Manufacturer	Qty
U1	Synchronous Buck Regulator	LM20124	Texas Instruments	1
C <sub>IN</sub>	47μF, 1206, X5R, 6.3V	C3216JB0J476M	TDK	1
C <sub>OUT</sub>	47μF, 1206, X5R, 6.3V	C3216JB0J476M	TDK	1
L	1μH, 24mΩ	IHLP1616BZER1R0M11	Vishay	1
R <sub>F</sub>	1Ω, 0402	CRCW04021R0J-e3	Vishay-Dale	1
C <sub>F</sub>	1μF, 0402, X7R, 10V	GRM155R61A105KE15	Murata	1
C <sub>vcc</sub>	1μF, 0402, X7R, 10V	GRM155R61A105KE15	Murata	1
R <sub>C1</sub>	3.92kΩ, 0402	CRCW04023922F-e3	Vishay-Dale	1
C <sub>C1</sub>	1.8nF, 0402, X7R, 25V	VJ0402Y182KXXA	Vishay	1
C <sub>ss</sub>	33nF, 0402, X7R, 25V	VJ0402G333KXJA	Vishay-Vitramon	1
R <sub>FB1</sub>	4.99kΩ, 0402	CRCW04024992F-e3	Vishay-Dale	1
R <sub>FB2</sub>	10kΩ, 0402	CRCW04021002F-e3	Vishay-Dale	1



The calculated component PCB area for this design is 65 mm<sup>2</sup>. The efficiency vs. I<sub>OUT</sub>, output voltage ripple, and transient response are shown below for this solution.

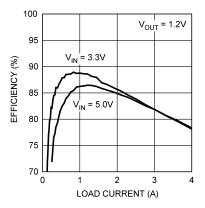


Figure 6. Efficiency vs I<sub>OUT</sub>

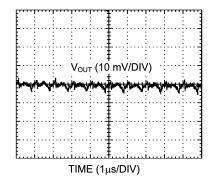


Figure 7. Output Voltage Ripple

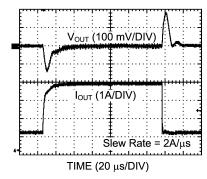


Figure 8. Transient Response

# 4 Solution Optimized for Transient Response

To optimize the transient response the switching frequency should be as high as possible. A high switching frequency allows the crossover frequency to maximized and the inductor size to be minimized. A small inductor permits also permits the inductor current to quickly ramp during a load step change.



#### 4.1 Inductor Selection

The inductor should be sized for approximately 30% ripple current. For  $V_{IN} = 5V$ ,  $V_{OUT} = 1.2V$ ,  $f_{SW} = 1.5$  MHz, and  $I_{OUT} = 4A$ , the ideal inductance value can be calculated from equation 1 to be 0.51  $\mu$ H. Once an inductance value is calculated, an actual inductor needs to be selected based on a trade-off between physical size, efficiency, and current carrying capability. Since the purpose of this design is minimize the size, it is possible to select inductor values smaller than 0.51 $\mu$ H, as long as the output current plus one-half the peak to peak ripple current does not exceed the device current limit. After examining several inductor vendors, a TDK SPM6530T-R47M170 inductor was selected. This 0.47 $\mu$ H inductor results in a peak-to-peak ripple current of 1.3A and 1.08A when the converter is operating from 5V and 3.3V respectively. For a design where size is critical, the TDK SPM6530T-R47M170 inductor offers small size with relatively low DC losses (3.3 m $\Omega$  DCR), and saturation current rating (17A  $I_{SAT}$  rating).

# 4.2 Output Capacitor Selection

A Sanyo 470  $\mu F$  POSCAP capacitor with 10 m $\Omega$  of series resistance (ESR) is selected for the output capacitor to provide good transient and DC performance in a relatively small package. If desired the output voltage ripple can be further reduced by placing a 47  $\mu F$  ceramic capacitor in parallel with the Sanyo POSCAP.

#### 4.3 Compensation Selection

The compensation network was selected using the excel design tool (available online) to give a crossover frequency of 105 kHz. For this target crossover frequency, operating conditions, and filter components a value for  $C_{\text{C1}}$  of 0.47 nF and a value for  $R_{\text{C1}}$  of 40 k $\Omega$  were selected. Since the output capacitor value and ESR are large an additional capacitor  $C_{\text{C2}}$  is recommended. For this design  $C_{\text{C2}}$  is 100pF.

The final schematic for a 5V to 1.2V or 3.3V to 1.2V conversion is shown in Figure 1.

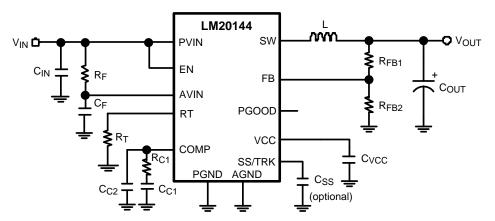


Figure 9. 1.2V Output Solution Optimized for Load Transients

Table 3. Transient Response Bill of Materials ( $V_{IN} = 5V$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT(MAX)} = 4A$ ,  $f_{SW} = 1.5$  MHz)

Designator	Description	Part Number	Manufacturer	Qty
U1	Synchronous Buck Regulator	LM20144	Texas Instruments	1
C <sub>IN</sub>	47μF, 1206, X5R, 6.3V	C3216JB0J476M	TDK	1
C <sub>OUT</sub>	470μF, D4D,POSCAP, 6.3V	6TPD470M	Sanyo	1
L	0.47μH, 3.3mΩ	SPM6530T-R47M170	TDK	1
R <sub>F</sub>	1Ω, 0603	CRCW06031R0J-e3	Vishay-Dale	1
C <sub>F</sub>	1μF, 0603, X7R, 10V	GRM188R71A105KA01	Murata	1
C <sub>vcc</sub>	1μF, 0603, X7R, 10V	GRM188R71A105KA01	Murata	1
R <sub>C1</sub>	40.0kΩ,0603	CRCW06034002F-e3	Vishay-Dale	1
C <sub>C1</sub>	0.47nF, 0603, X7R, 25V	GRM188R71H471KA01	Murata	1
C <sub>C2</sub>	100pF, 0603,50V,COG	GRM1885C1H101JA01	Murata	1



Table 3. Transient Response Bill of Materials ( $V_{IN} = 5V$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT(MAX)} = 4A$ ,  $f_{SW} = 1.5$  MHz) (continued)

Designator	Description	Part Number	Manufacturer	Qty
C <sub>ss</sub>	33nF,0603,X7R,25V	VJ0603Y333KXXA	Vishay-Vitramon	1
R <sub>FB1</sub>	4.99kΩ,0603	CRCW06034992F-e3	Vishay-Dale	1
R <sub>FB2</sub>	10kΩ, 0603	CRCW06031002F-e3	Vishay-Dale	1
R <sub>T</sub>	48.7kΩ, 0603	CRCW06034872F-e3	Vishay-Dale	1

The calculated component PCB area for this design is 129 mm<sup>2</sup>. The efficiency vs. I<sub>OUT</sub>, output voltage ripple, and transient response are shown below for this solution.

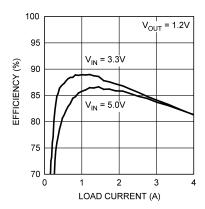


Figure 10. Efficiency vs  $I_{\text{OUT}}$ 

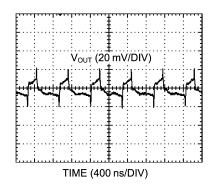


Figure 11. Output Voltage Ripple

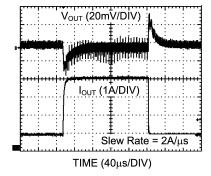


Figure 12. Transient Response

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